

Vishay Semiconductors

COMPLIANT

# **High Performance Schottky Rectifier, 400 A**



PRIMARY CHARACTERISTICS					
I <sub>F(AV)</sub>	400 A				
$V_{R}$	135 V, 150 V				
Package	TO-244				
Circuit configuration	Two diodes common cathode				

#### **FEATURES**

- 175 °C T<sub>J</sub> operation
- · Center tap module
- · Low forward voltage drop
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- UL approved file E222165
- · Designed and qualified for industrial level
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

### **DESCRIPTION / APPLICATIONS**

The VS-409CNQ... center tap Schottky rectifier module series has been optimized for low reverse leakage at high temperature. The proprietary barrier technology allows for reliable operation up to 175 °C junction temperature. Typical applications are in high current switching power supplies, plating power supplies, UPS systems, converters, freewheeling diodes, welding, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS						
SYMBOL	CHARACTERISTICS	VALUES	UNITS			
I <sub>F(AV)</sub>	Rectangular waveform	400	Α			
V <sub>RRM</sub>	Range	135/150	V			
I <sub>FSM</sub>	t <sub>p</sub> = 5 μs sine	20 000	Α			
V <sub>F</sub>	200 A <sub>pk</sub> , T <sub>J</sub> = 125 °C (per leg)	0.75	V			
TJ	Range	-55 to +175	°C			

VOLTAGE RATINGS				
PARAMETER	SYMBOL	VS-409CNQ135PbF	VS-409CNQ150PbF	UNITS
Maximum DC reverse voltage	$V_R$	135	150	V
Maximum working peak reverse voltage	$V_{RWM}$	133	130	<b>v</b>

ABSOLUTE MAXIMUM RATINGS						
PARAMETER		SYMBOL	L TEST CONDITIONS		VALUES	UNITS
Maximum average forward current (fig. 5) per leg per device		- I <sub>F(AV)</sub>	50 % duty cycle at $T_C$ = 129 °C, rectangular waveform		200	^
					400	
Maximum peak one cycle non-	Maximum peak one cycle non-repetitive		5 µs sine or 3 µs rect. pulse	Following any rated load condition and with rated	20 000	A
surge current per leg (fig. 7)		I <sub>FSM</sub>	10 ms sine or 6 ms rect. pulse	V <sub>RRM</sub> applied	2300	
Non-repetitive avalanche energy per leg		E <sub>AS</sub>	T <sub>J</sub> = 25 °C, I <sub>AS</sub> = 5.5 A, L = 1 mH		15	mJ
Repetitive avalanche current per leg		I <sub>AR</sub>	Current decaying linearly to zero in 1 $\mu$ s Frequency limited by T <sub>J</sub> maximum V <sub>A</sub> = 1.5 x V <sub>R</sub> typical		1	Α

Revision: 11-May-17 **1** Document Number: 94207

## Vishay Semiconductors

ELECTRICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
	V <sub>FM</sub> <sup>(1)</sup>	200 A	T <sub>.1</sub> = 25 °C	1.13	V
Maximum forward voltage drop per leg		400 A	1j=25 C	1.46	
See fig. 1		200 A	T <sub>.1</sub> = 125 °C	0.75	
		400 A	1] = 125 0	0.89	
Maximum reverse leakage current per leg See fig. 2	I <sub>RM</sub> <sup>(1)</sup>	T <sub>J</sub> = 25 °C	V <sub>R</sub> = Rated V <sub>R</sub>	6	mA
		T <sub>J</sub> = 125 °C	VR = nated VR	85	IIIA
Maximum junction capacitance per leg	C <sub>T</sub>	V <sub>R</sub> = 5 V <sub>DC</sub> (test signal range 100 kHz to 1 MHz) 25 °C		6000	pF
Typical series inductance per leg	L <sub>S</sub>	From top of terminal hole to mounting plane		5.0	nH
Maximum voltage rate of change	dV/dt	Rated V <sub>R</sub>		10 000	V/µs

#### Note

 $<sup>^{(1)}\,</sup>$  Pulse width  $<300~\mu s,$  duty cycle <2~%

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNITS	
Maximum junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>	-55	-	175	°C	
Thermal resistance, junction to case per leg	D	-	-	0.19	°C/W	
Thermal resistance, junction to case per module	- R <sub>thJC</sub>	-	-	0.095		
Thermal resistance, case to heatsink	R <sub>thCS</sub>	-	0.10	-		
Weight		-	68	-	g	
		-	2.4	-	OZ.	
Mounting torque		35.4 (4)		53.1 (6)	lbf ⋅ in (N ⋅ m)	
Mounting torque center hole		30 (3.4)		40 (4.6)		
Terminal torque		30 (3.4)	-	44.2 (5)	()	
Vertical pull		-	-	80	llet :-	
2" lever pull		-	-	35	- lbf ⋅ in	

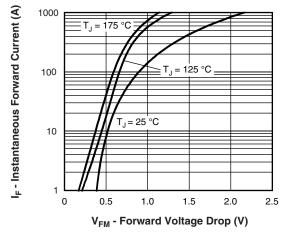


Fig. 1 - Maximum Forward Voltage Drop Characteristics

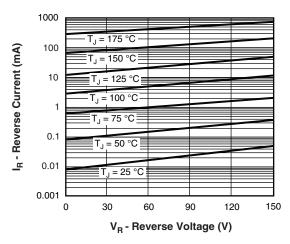


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage



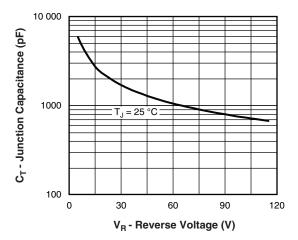


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

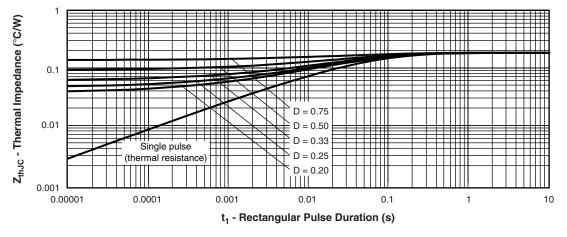


Fig. 4 - Maximum Thermal Impedance Z<sub>thJC</sub> Characteristics

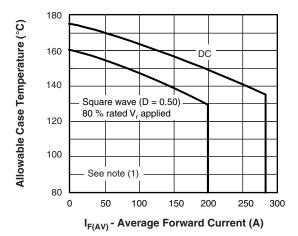
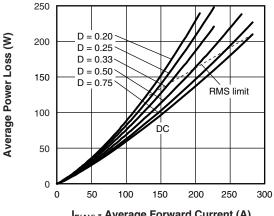


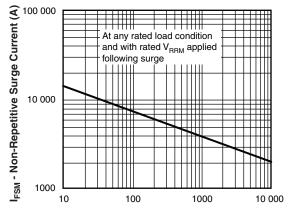
Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current



I<sub>F(AV)</sub> - Average Forward Current (A)

Fig. 6 - Forward Power Loss Characteristics

### Vishay Semiconductors



t<sub>p</sub> - Square Wave Pulse Duration (μs)

Fig. 7 - Maximum Non-Repetitive Surge Current

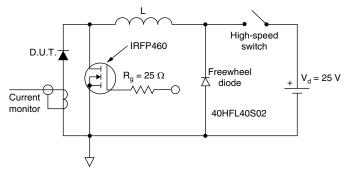


Fig. 8 - Unclamped Inductive Test Circuit

#### Note

 $\begin{array}{ll} \text{(1)} & \text{Formula used: } T_C = T_J - (Pd + Pd_{REV}) \times R_{th,JC}; \\ Pd = \text{forward power loss} = I_{F(AV)} \times V_{FM} \text{ at } (I_{F(AV)}/D) \text{ (see fig. 6)}; \\ Pd_{REV} = \text{inverse power loss} = V_{R1} \times I_R \text{ (1 - D); } I_R \text{ at } V_{R1} = Rated \ V_R \\ \end{array}$ 

#### **ORDERING INFORMATION TABLE**

